

REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP

NOTE:

1.MATERIAL:

INSULATOR: THERMOPLASTIC UL94V-0.
TERMINAL: COPPER ALLOY T=0.15mm.
SWITCH: COPPER ALLOY T=0.15mm.
SHELL: SUS T=0.15mm.
SWP: SUS 10.00* ϕ 0.20mm.
CRANK AXLE: SUS 304

2.PLATED:

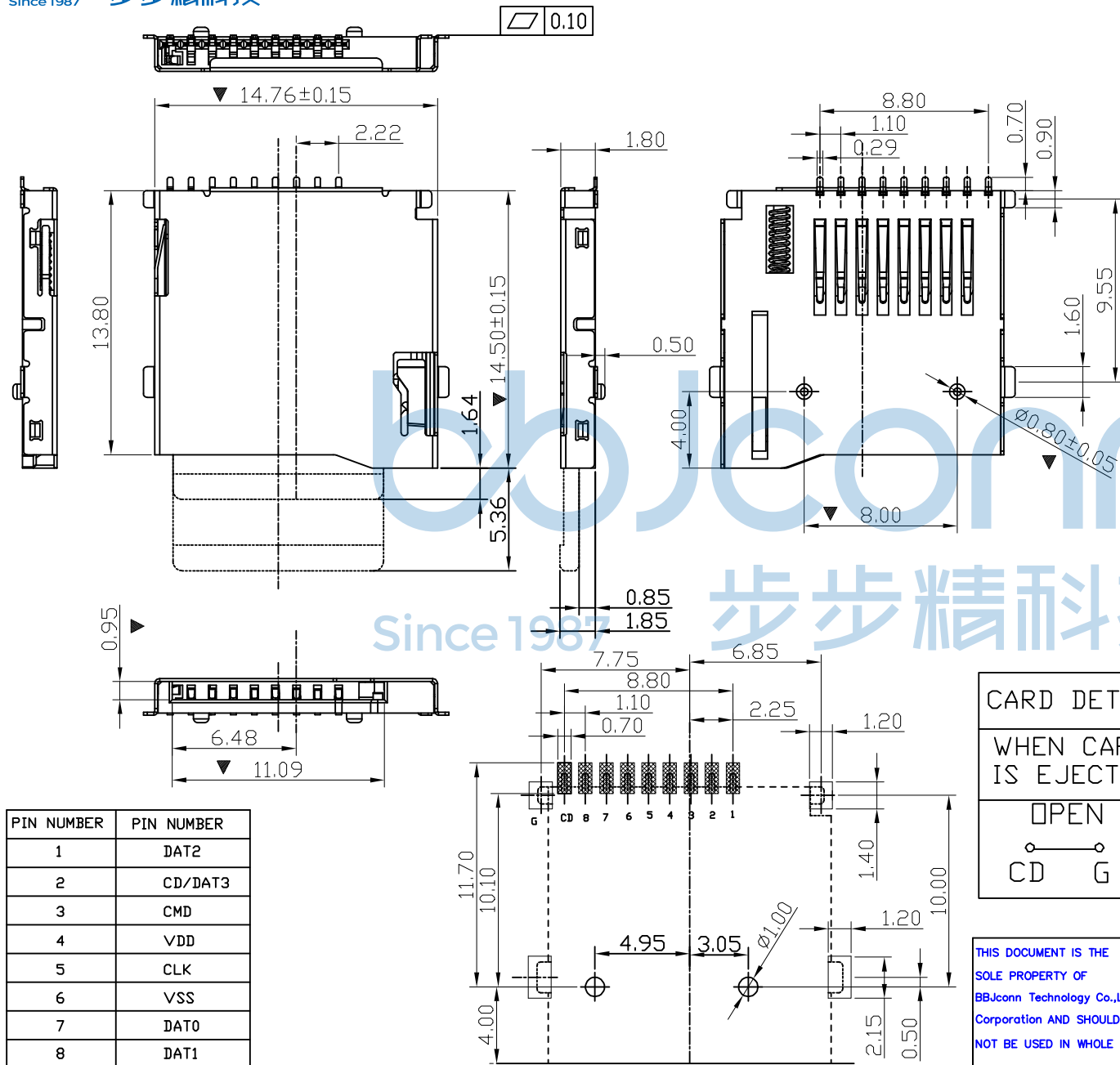
CONTACT: 1 μ " GOOD PLATING OVERALL
50 μ " NI UNDERPLATED OVERALL.
SHELL: 50 μ " NI UNDERPLATED OVERALL.

3.ELECTRICAL PERFORMANCE:

CONTACT RESISTANCE: 100 MILLIOHMS Max.
DIELECTRIC STRENGTH: 500V AC FOR 1 MIN

4.MECHANICAL PERFORMANCE:

CARD INSERT FORCE: 0.5~1.2Kgf
CARD EJECTION FORCE: 0.5~1.2kgf
CYCLE LIFE: 10000 TIMES.



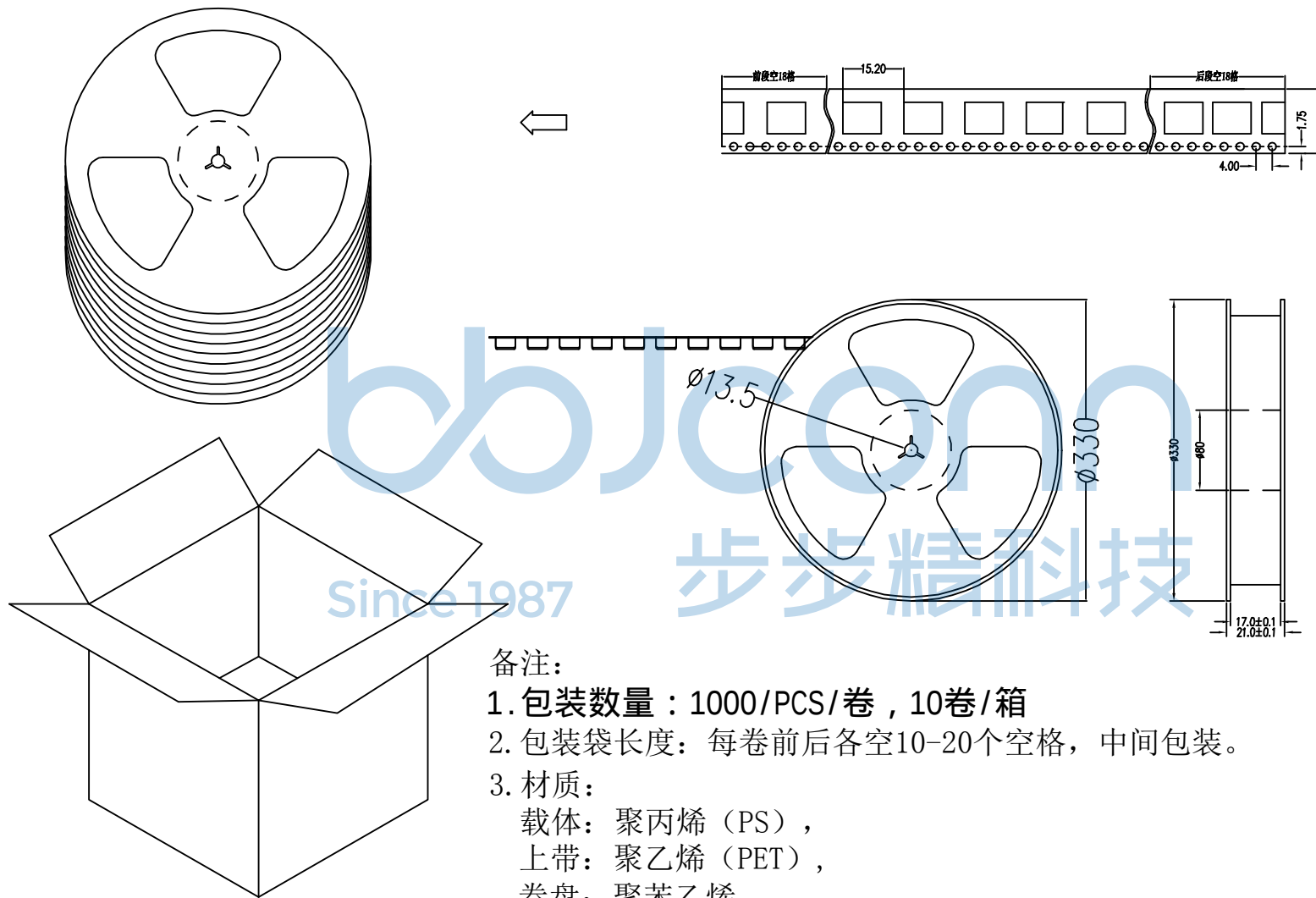
PIN NUMBER	PIN NUMBER
1	DAT2
2	CD/DAT3
3	CMD
4	VDD
5	CLK
6	VSS
7	DAT0
8	DAT1
CD	CAED DETECTION
G	GROUND

CARD DETECTION SWITCH	
WHEN CARD IS EJECTED	WHEN CARD IS INSETTED
OPEN	CLOSE

Recommended PCB Layout

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PDWG.NO: 0390-1

深圳市步步精科技有限公司	
.X: ± 0.38 .XX: ± 0.25 .XXX: ± 0.13	X': $\pm 3'$ X'': $\pm 2'$ X'X': $\pm 1'$
NAME: 卡座 TF CARD PUSH 外焊式 9PIN 带CDPIN H=1.85 贴片 带柱 编带	PJ. NO.: 142-106-090001-S4G
APPD. JM_Zheng	SIZE: A4 DRW NO.:
CHKD. LYX	FINISH: SEE NOTES MAT'L.: SEE NOTES
DR. TSP	SCALE: N/A REV.: A0 UNIT: mm PAGE: 1/2



备注:

1. 包装数量: 1000/PCS/卷, 10卷/箱
2. 包装袋长度: 每卷前后各空10-20个空格, 中间包装。
3. 材质:
载体: 聚丙烯 (PS),
上带: 聚乙烯 (PET),
卷盘: 聚苯乙烯。

纸箱规格: 345*345*23MM

纸箱规格: 345*345*35MM

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